

**ORGANISATION MONDIALE  
DU COMMERCE**

**ORGANIZACIÓN MUNDIAL  
DEL COMERCIO**

**WORLD TRADE ORGANIZATION**

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Référence: WLI/101

15 August 1997

**MARRAKESH AGREEMENT ESTABLISHING  
THE WORLD TRADE ORGANIZATION  
DONE AT MARRAKESH ON 15 APRIL 1994**

**GENERAL AGREEMENT ON TARIFFS AND TRADE 1994**

**CERTIFICATION OF MODIFICATIONS TO SCHEDULE LXXXII - HONG KONG, CHINA**

**TRANSMISSION OF CERTIFIED TRUE COPY**

I have the honour to furnish herewith a certified true copy of the Certification of Modifications to Schedule LXXXII - Hong Kong, China, dated 16 July 1997.

R. Ruggiero  
Director-General

**SCHEDULES OF TARIFF CONCESSIONS TO THE  
GENERAL AGREEMENT ON TARIFFS AND TRADE 1994**

**CERTIFICATION OF MODIFICATIONS**

**SCHEDULE LXXXII - HONG KONG, CHINA**

WHEREAS the CONTRACTING PARTIES to the General Agreement on Tariffs and Trade 1947 adopted, on 26 March 1980, a Decision on Procedures for Modification and Rectification of Schedules of Tariff Concessions (BISD 27S/25);

WHEREAS in accordance with the provisions of the above-mentioned Decision, a draft containing modifications to Schedule LXXXII - Hong Kong, China was communicated to all Members of the World Trade Organization in document G/MA/TAR/RS/21 on 16 April 1997;

IT IS HEREBY CERTIFIED that the modifications to Schedule LXXXII - Hong Kong, China are established in conformity with the above-mentioned Decision.

The annexed modifications shall become effective on 16 July 1997.

This Certification is deposited with the Director-General of the World Trade Organization, who shall promptly furnish a certified true copy to each Member of the World Trade Organization. It shall be registered in accordance with the provisions of Article 102 of the Charter of the United Nations.

DONE at Geneva this sixteenth day of July, one thousand nine hundred and ninety-seven.

R. Ruggiero

Certified true copy:

Director-General

**SCHEDULE LXXXII - HONG KONG, CHINA**

**Modifications**

16 July 1997

# Hong Kong

26 March 1996

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs
3818	Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics.	0	0	1997	WT/Let				
38180000	-Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics	0	0	1997	WT/Let				
7017	Laboratory, hygienic or pharmaceutical glassware, whether or not graduated or calibrated								
70171000	-Of fused quartz or other fused silica	0	0	1995	WT/Let		UR/94		
ex70171000	--Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	0	0	1995	WT/Let		UR/94		
8419	Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilising, pasteurising, steaming, drying, evaporating, vaponising, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non-electric								
84198900	-Other machinery, plant and equipment								
ex84198900	--Other								
84198900	---Chemical vapor deposition apparatus for semiconductor production	0	0	1997	WT/Let				

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first</u> <u>incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
	-Parts:									
84199090	---Other									
ex84199090	----Parts of chemical vapor deposition apparatus for semiconductor production	0	0	1997	WT/Let					
8421	Centrifuges, including centrifugal dryers; filtering or purifying machinery and apparatus, for liquids or gases.									
	-Centrifuges, including centrifugal dryers:									
84211900	--Other than cream separators and clothes-dryers	0	0	1995	WT/Let			UR/94		
ex84211900	---Spin dryers for semiconductor wafer processing	0	0	1995	WT/Let			UR/94		
	-Parts:									
84219100	--Of centrifuges, including centrifugal dryers									
ex84219100	---Parts of spin dryers for semiconductor wafer processing	0	0	1997	WT/Let					
8424	Mechanical appliances (whether or not hand-operated) for projecting, dispersing or spraying liquids or powders; fire extinguishers, whether or not charged; spray guns and similar appliances; steam or sand blasting machines and similar jet projecting machines.									
	-Other appliances:									
84248900	--Other									
ex84248900	---Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	0	0	1997	WT/Let					
ex84248900	----Spraying appliances for etching, stripping or cleaning semiconductor wafers	0	0	1997	WT/Let					

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	Concession first incorporated in a GATT Schedule	Earlier INRs ODCs
84249000	-Parts						
ex84249000	--Parts of spraying appliances for etching, stripping or cleaning semiconductor wafers	0	0	1997	WT/Let		
8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes.						
84561000	-Operated by laser or other light or photon beam processes						
ex84561000	--Machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	0	0	1997	WT/Let		
	-Other						
84569100	--For dry-etching patterns on semiconductor materials	0	0	1997	WT/Let		
ex84569100	---Apparatus for stripping or cleaning semiconductor wafers	0	0	1997	WT/Let		
84569900	--Other						
ex84569900	---Focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	0	0	1997	WT/Let		
ex84569900	---Lasercutters for cutting contacting tracks in semiconductor production by laser beam	0	0	1997	WT/Let		
8464	Machine-tools for working stone, ceramics, concrete, asbestos-cement or like mineral materials or for cold working glass.						
84641000	-Sawing machines						
ex84641000	--Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	0	0	1997	WT/Let		
84642000	-Grinding or polishing machines						

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex84642000	--Grinding, polishing and lapping machines for processing of semiconductor wafers	0	0	1997	WT/Let			
84649000	-Other							
ex84649000	--Dicing machines for scribing or scoring semiconductor wafers	0	0	1997	WT/Let			
8466	Parts and accessories suitable for use solely or principally with the machines of headings Nos. 8456 to 8465, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine-tools; tool holders for any type of tool for working in the hand.							
-Other								
84669100	--For machines of heading No 8464							
ex84669100	---Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	0	0	1997	WT/Let			
ex84669100	---Parts of dicing machines for scribing or scoring semiconductor wafers	0	0	1997	WT/Let			
ex84669100	---Parts of grinding, polishing and lapping machines for processing of semiconductor wafers	0	0	1997	WT/Let			
84669300	--For machines of headings Nos. 8456 to 8461							
ex84669300	---Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	0	0	1997	WT/Let			
ex84669300	---Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam	0	0	1997	WT/Let			

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	Concession first incorporated in a GATT Schedule	Earlier INRs ODCs
ex84669300	---Parts of machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	0	0	1997	WT/Let		
ex84669300	---Parts of apparatus for stripping or cleaning semiconductor wafers	0	0	1997	WT/Let		
ex84669300	---Parts of machines for dry-etching patterns on semiconductor materials	0	0	1997	WT/Let		
8469	Typewriters other than printers of heading No. 8471, word-processing machines.						
	-Automatic typewriters and word-processing machines:						
84691100	--Word-processing machines	0	0	1997	WT/Let		
8470	Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers.						
84701000	-Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions	0	0	1997	WT/Let		
	-Other electronic calculating machines:						
84702100	--Incorporating a printing device	0	0	1997	WT/Let		
84702900	--Other	0	0	1997	WT/Let		
84703000	-Other calculating machines	0	0	1997	WT/Let		
84704000	-Accounting machines	0	0	1997	WT/Let		
84705000	-Cash registers	0	0	1997	WT/Let		
84709000	-Other	0	0	1997	WT/Let		

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u> <u>ODCs</u>
8471	Automatic data processing machines and units thereof; magnetic or optical readers; machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included.						
84711000	-Analogue or hybrid automatic data processing machines	0	0	1997	WT/Let		
84713000	-Portable digital automatic data processing machines, weighing no more than 10 kg, consisting of at least a central processing unit, a keyboard and a display	0	0	1995	WT/Let	UR/94	
	-Other digital automatic data processing machines:						
84714100	--Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined	0	0	1995	WT/Let	UR/94	
84714900	--Other, presented in the form of systems	0	0	1995	WT/Let	UR/94	
84715000	-Digital processing units other than those of subheadings 84714100 and 84714900, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units	0	0	1995	WT/Let	UR/94	
84716000	-Input or output units, whether or not containing storage units in the same housing	0	0	1995	WT/Let	UR/94	
84717000	-Storage units	0	0	1995	WT/Let	UR/94	
84718000	-Other units of automatic data processing machines	0	0	1995	WT/Let	UR/94	
ex84718000	--Authentication units for data processing machines (ciphering machines)	0	0	1995	WT/Let	UR/94	
84719000	-Other	0	0	1995	WT/Let	UR/94	

